EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	233549	silicon adj nitride or "si. sub.3n.sub.4" or si3n4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:11
S2	1882	(niobium nb columbium cb) adj2 powder\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:12
S3	894140	capacitor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:12
S4	18	St same S2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:12
S7	264855	(si or silicon) near10 nitride	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:24
S8	21	S2 same S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:25
S17	4338	(niobium nb columbium cb) same S1	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:42

S18	661	S3 and S17	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:43
S19	216414	"361"/\$.ccls. or "75"/\$. ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:43
S20	42	S18 and S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:43
S21	16780	(niobium nb columbium cb) and S1	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:48
S22	4258	S3 and S21	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:48
S23	173	S19 and S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/16 17:48
S30	258618	(si or silicon) near3 nitride or "si.sub.3n. sub.4" or si3n4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 09:26
S35	9120	(film adj forming film- forming valve) adj metal	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM TDB	OR	ON	2009/03/17 09:43

S36	813229	tantalum ta niobium nb comlumbium cb	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 09:43
S37	894463	capacitor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 09:43
S44	7010	(S35 S36) near3 powder \$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 10:00
S46	7010	(S35 S36) near3 powder \$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 10:01
S47	1961	S37 same S46	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 10:01
S48	39	S30 and S47	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 10:02
S51	653303	etching	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 10:43
S52	105	S44 same S51	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/17 10:44
S53	174859	(si silicon) adj2 nitride "si.sub3n.sub.4" or "si. sub."\$3 adj "n.sub."\$2	US-PGPUB; USPAT; USOCR	OR	ON	2009/05/19 09:02

S54	241492	(si silicon) adj2 nitride "si.sub3n.sub.4" or "si. sub."\$3 adj "n.sub."\$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:02
S55	503059	niobium or nb or columbium or cb or (film film-forming valve) adj2 metal	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:03
S56	1650333	powder\$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:03
S57	13562	S55 with S56	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:04
S58	255	S54 same S57	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:04
S59	1269386	anode or capacitor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:04
S60	25	S58 and S59	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:04
S61	9892	etch\$5 with S55	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:47

S62	2651	S53 and S61	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:48
S63	1273	S59 and S62	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:48
S64	9892	etch\$5 with S55	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:48
S65	27417	S55 same S59	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:49
S66	1325	S64 and S65	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:49
S67	451	S64 same S54	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:50
S68	445061	impregnat\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 09:54
S69	72	S61 same S68	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM TDB	OR	ON	2009/05/19 09:54

S70	838	etch\$5 adj4 powder\$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 10:20
S71	57	S54 and S70	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 10:20
S78	208	leach\$5 adj5 etch\$5	US-PGPUB; USPAT; USOCR	OR	ON	2009/05/19 11:40
S79	7	S59 same S78	US-PGPUB; USPAT; USOCR	OR	ON	2009/05/19 11:41
S80	2441	75/252,255.245.cds. or 428/570.cds. or 361/528.cds.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 15:42
S81	2222	(niobium nb columbium cb valve adj metal) adj2 powder\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 15:43
S82	252411	(si silicon) adj nitride or "si.sub.3n.sub.4" or si3n4 silicon-nitride silicon near1 (nitride or nitrogen)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 15:44
S83	24	S81 same S82	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/05/19 15:44
S84	2487	(niobium nb columbium cb) adj2 (powder particle or particulate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:49
S85	447152	surface near5 (powder or particle particulate)	US-PGPUB; USPAT; USOCR; PPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:50

S86	244878	(si or silicon) adj2 nitride or "Si.sub."\$2 near2 "n.sub."\$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:52
S87	244878	silicon-nitride S86	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:53
S88	2693	S85 same S87	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:53
S89	7	S84 and S88	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:53
S91	395	S84 same S85	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:55
S92	912719	capacitor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:55
S93	250	S91 and S92	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:56
S95	4234661	silicon si	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/02 16:56

S96	82	S93 and S95	US-PGPUB:	OB	ON	2009/07/02
000	OZ.		USPAT: USOCR:	OI t	OIV	16:56
			FPRS; EPO;			10100
			JPO;			
			DERWENT;			
			IBM_TDB			

^{7/6/09 2:04:38} PM

C:\ Documents and Settings\ nmai\ My Documents\ EAST\ Workspaces\ 10578784.wsp